TF Semiconductor Solutions
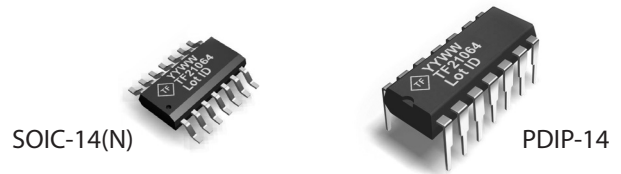
TF21064

High-Side and Low-Side Gate Driver

Features

- Floating high-side driver in bootstrap operation to 600V
- Drives two N-channel MOSFETs or IGBTs in a half bridge configuration
- Outputs tolerant to negative transients
- Wide logic and low side gate driver supply voltage: 10V to 20V
- Wide logic supply voltage offset voltage: -5V to 5V
- Logic input (HIN and LIN) 3.3V capability
- Schmitt triggered logic inputs with internal pull down
- Undervoltage lockout for high and low side drivers
- Extended temperature range:-40°C to +125°C

Description

The TF21064 is a high voltage, high speed gate driver capable of driving N-channel MOSFETs and IGBTs in a half bridge configuration. TF Semiconductors's high voltage process enables the TF21064's high side to switch to 600V in a bootstrap operation.

The TF21064 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction. The TF21064 is offered in PDIP-14 and SOIC-14(N) packages and operates over an extended -40 °C to +125 °C temperature range.
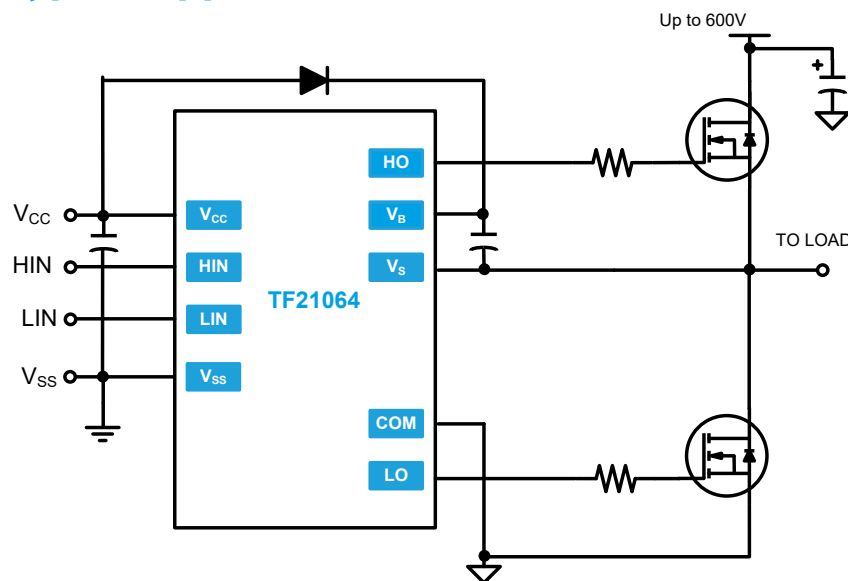
SOIC-14(N)   PDIP-14

Applications

- DC-DC Converters
- AC-DC Inverters
- Motor Controls
- Class D Power Amplifiers

Ordering Information

Year **Y**ear **W**eek **W**eek

PART NUMBER	PACKAGE	PACK / Qty	MARK
TF21064-TUU	SOIC-14(N)	Tube / 50	TF YYWW TF21064 Lot ID
TF21064-TUH		T&R / 2500	
TF21064-3BS	PDIP-14	Tube / 25	TF YYWW TF21064 Lot ID

Typical Application

Pin Diagrams

V_{CC}	1	14	NC
HIN	2	13	V_B
LIN	3	12	HO
NC	4	11	V_S
V_{SS}	5	10	NC
COM	6	9	NC
LO	7	8	NC
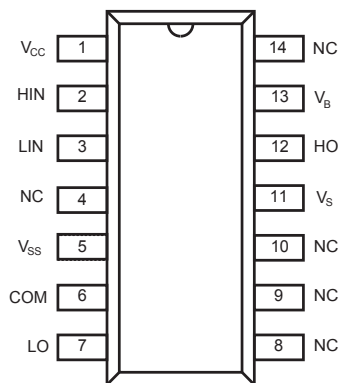
Top View: SOIC-14, PDIP-14

TF21064

Pin Descriptions

PIN NAME	PIN DESCRIPTION
HIN	Logic input for high-side gate driver output, in phase with HO (referenced to VSS).
LIN	Logic input for low side gate driver output, in phase with LO (referenced to VSS)
VSS	Logic ground
NC	No connect
COM	Low-side return
LO	Low-side gate drive output
V_{CC}	Low-side and logic fixed supply
V_B	High-side floating supply
HO	High-side gate drive output
V_S	High-side floating supply return

Functional Block Diagram
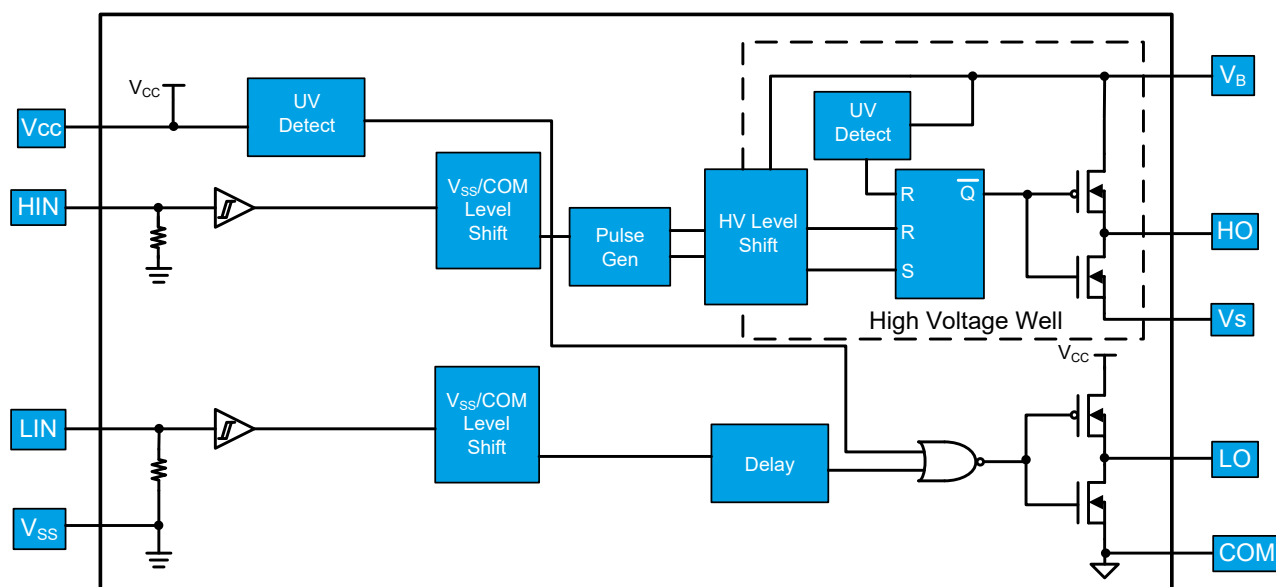
Absolute Maximum Ratings *(NOTE1)*

V_B - High side floating supply voltage.........................-0.3V to +624V
V_S - High side floating supply offset voltage......V_B-24V to V_B+0.3V
V_{HO} - High side floating output voltage...............V_S-0.3V to V_B+0.3V
dV_S / dt - Offset supply voltage transient.............................50 V/ns
V_{DT}- Programmable dead time pin voltage.......V_{SS}-0.3V to V_B+0.3V

V_{CC}-Low side and logic fixed supply voltage.....................-0.3V to +24V
V_{LO} - Low side output voltage.................................-0.3V to V_{CC}+0.3V

V_{SS} - Logic supply offset voltage......................V_{CC}- 24V to V_{CC}+0.3V
V_{IN} - Logic input voltage (HIN and LIN).........V_{SS}- 0.3V to V_{CC}+0.3V

P_D - Package power dissipation at $T_A \leq 25$ °C
   SOIC-14...1.0W
   PDIP-14...1.6W

SOIC-14 Thermal Resistance *(NOTE2)*
   θ_{JA}...120 °C/W

PDIP-14 Thermal Resistance *(NOTE2)*
   θ_{JA}...75 °C/W

T_J - Junction operating temperature ....+150 °C
T_L - Lead temperature (soldering, 10s) .... +300 °C
T_{stg} - Storage temperature range ....-55 °C to +150 °C

NOTE2 *When mounted on a standard JEDEC 2-layer FR-4 board.*

NOTE1 *Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

Recommended Operating Conditions

Symbol	Parameter	MIN	MAX	Unit
V_B	High side floating supply absolute voltage	V_S + 10	V_S + 20	V
V_S	High side floating supply offset voltage	*(NOTE 3)*	600	V
V_{HO}	High side floating output voltage	V_S	V_B	V
V_{CC}	Low side fixed supply voltage	10	20	V
V_{LO}	Low side output voltage	COM	V_{CC}	V
V_{IN}	Logic input voltage (HIN & LIN)	V_{SS}	5	V
V_{DT}	Programmable deadtime pin voltage	V_{SS}	V_{CC}	V
V_{SS}	Logic ground	-5	5	V
T_A	Ambient temperature	-40	125	°C

NOTE3 *Logic operational for V_S of -5 V to +600 V. Logic state held for V_S of -5 V to -V_{BS}.*

DC Electrical Characteristics *(NOTE4)*

V_{BIAS} (V_{CC}, V_{BS}) = 15V, V_{SS} = COM, and T_A = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	MIN	TYP	MAX	Unit
V_{IH}	Logic "1" input voltage	V_{CC} = 10 V to 20 V	2.5			V
V_{IL}	Logic "0" input voltage				0.6	
V_{OH}	High level output voltage, V_{BIAS} - V_O	I_O = 2mA		0.05	0.2	
V_{OL}	Low level output voltage, V_O	I_O = 2mA		0.02	0.1	
I_{LK}	Offset supply leakage current	VB = VS = 600V			50	µA
I_{BSQ}	Quiescent V_{BS} supply current	V_{IN} = 0V or 5V	20	75	130	
I_{CCQ}	Quiescent V_{CC} supply current	V_{IN} = 0V or 5V	60	120	180	
I_{IN+}	Logic "1" input bias current	V_{IN} = 5V		5	20	
I_{IN-}	Logic "0" input bias current	V_{IN} = 0V			5	
V_{BSUV+}	V_{BS} supply under-voltage positive going threshold		8.0	8.9	9.8	V
V_{BSUV-}	V_{BS} supply under-voltage negative going threshold		7.4	8.2	9.0	
V_{CCUV+}	V_{CC} supply under-voltage positive going threshold		8.0	8.9	9.8	
V_{CCUV-}	V_{CC} supply under-voltage negative going threshold		7.4	8.2	9.0	
V_{CCUVH} / V_{BSUVH}	Hysteresis		0.3	0.7		V
I_{O+}	Output high short circuit pulsed current	V_O = 0V, PW ≤ 10 µs	130	290		mA
I_{O-}	Output low short circuit pulsed current	V_O = 15V, PW ≤ 10 µs	270	600		

NOTE4 *The V_{IN}, V_{Th}, I_{IN} parameters are referenced to V_{SS} and are applicable to the two logic input pins: HIN and LIN. The V_O and I_O parameters are referenced to COM and are applicable to the respective output pins: HO and LO.*

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AC Electrical Characteristics

V_{BIAS} (V_{CC}, V_{BS}) = 15V and C_L = 100pF, V_{SS} = COM, and T_A = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	MIN	TYP	MAX	Unit
t_{ON}	Turn-on propagation delay	V_S = 0V		220	300	
t_{OFF}	Turn-off propagation delay	V_S = 0 V or 600V		200	280	
t_{DM}	Delay matchng			0	30	ns
t_r	Turn-on rise time	V_S = 0V		100	220	
t_f	Turn-off fall time	V_S = 0V		35	80	

Timing Waveforms
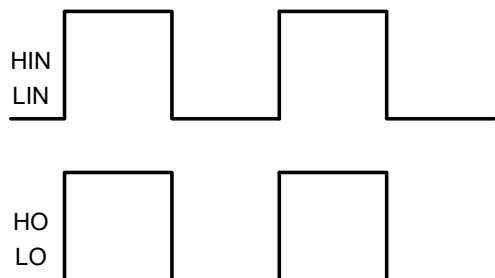
Figure 1. Input / Output Timing Diagram
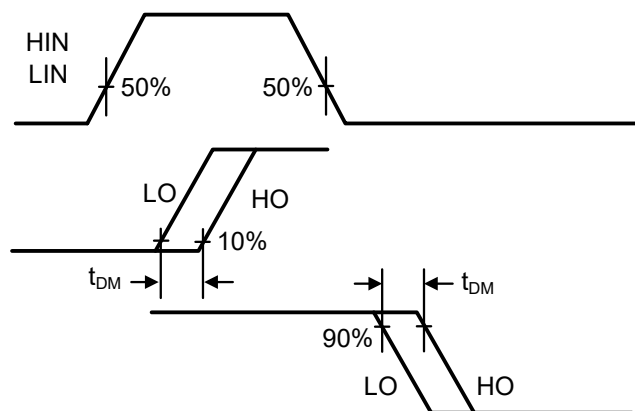
Figure 2. Delay Matching Waveform Definitions
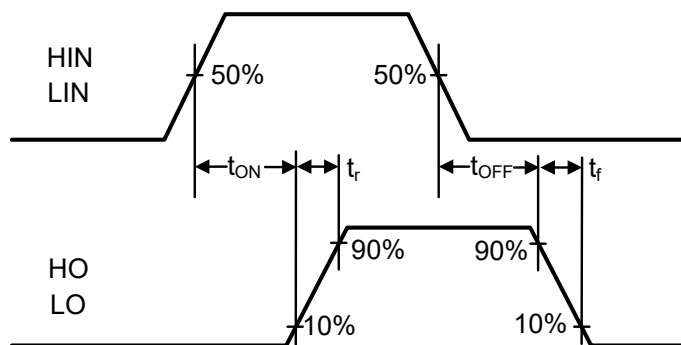
Figure 3. Switching Time Waveform Definitions

Package Dimensions (SOIC-14N)

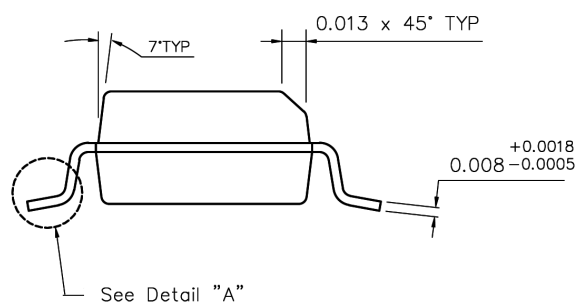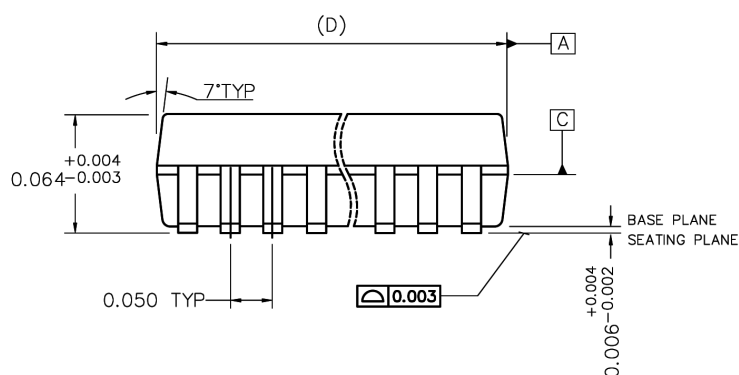Please contact support@tfsemi.com for package availability.

ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE NOTED

NOTES:

1. "D" & "E" ARE REFERENCE DATUMS AND DO NOT INCLUDE MOLD FLASH OR PROTRUSION. MOLD FLASH OR PROTRUSION SHALL NOT EXCEED 6 MILS PER SIDE.
2. "N" IS THE NUMBER OF TERMINAL POSITIONS.
3. FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITHIN 3 MILS (⌀ SEATING PLANE) OUTGOING ASSEMBLY & 4 MILS AFTER TEST.
4. THE BOTTOM PACKAGE LEAD SIDE MAY BE BIGGER THAN THE TOP PACKAGE LEAD SIDE BY 4 MILS (2 MILS PER SIDE). BOTTOM PACKAGE DIMENSION SHALL FOLLOW DIMENSION STATED IN THIS DRAWING.
5. THE BOTTOM EJECTOR PIN CONTAINS COUNTRY OF ORIGIN "INDO" AND MOLD ID. (REFER TO TABLE FOR OPTION).
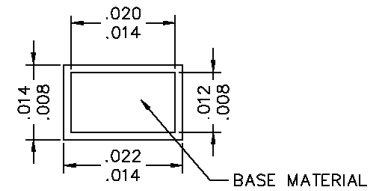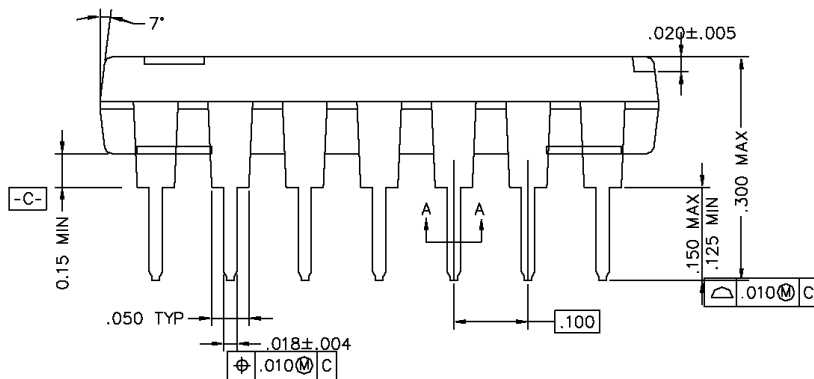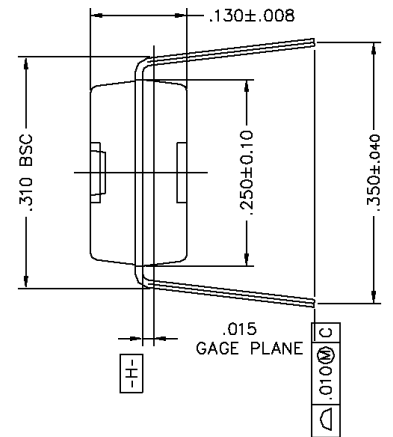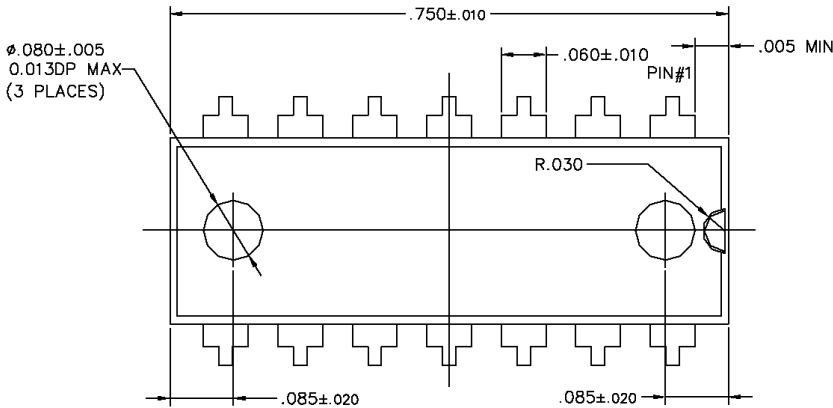6. THIS DRAWING CONFORMS TO JEDEC REF. MS−012 REV. E

GAUGE PLANE
0.010 BSC

Detail "A"
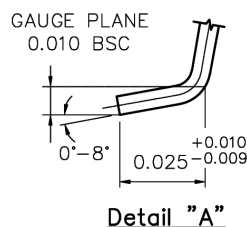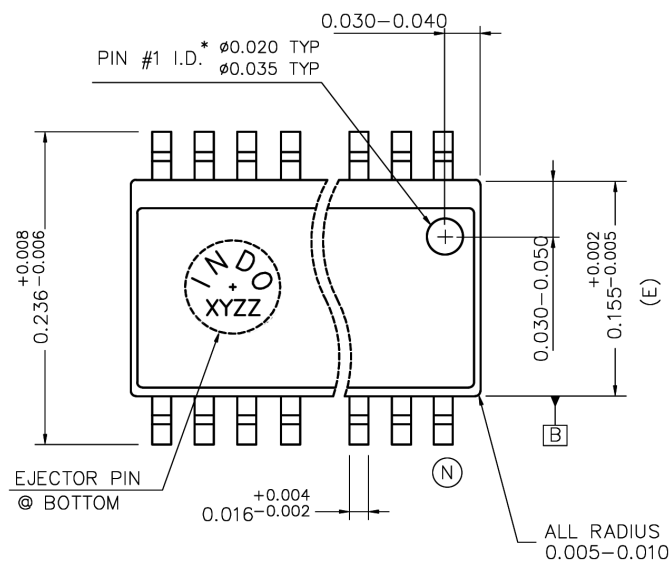
N	D VARIATION			MGP MOLD			
				STANDARD		MATRIX	
	MIN	NOM	MAX	PIN 1 I.D.	EJECT PIN	PIN 1 I.D.	EJECT PIN
08	0.189	0.193	0.196	N/A		YES	YES
14	0.337	0.339	0.344	YES	NO	YES	YES
16	0.386	0.390	0.393	N/A		YES	YES

Package Dimensions (PDIP-14)

Please contact support@tfsemi.com for package availability.

ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE NOTED

Note: Drawing conforms to jedec ref. MS-001 rev D

Revision Table

Rev.	Change	Owner	Date
1.0	First release, Advance Info ds	Keith Spaulding	11/24/2107

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